# 9-146281-0 - ACTIVE

### AMPMODU | AMPMODU Headers

TE Internal #: 9-146281-0 PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



## PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **40** 

Number of Rows: 1

## Features

## Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Breakaway

Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
PCB Mount Orientation	Vertical	
Number of Positions	40	
Number of Rows	1	
Board-to-Board Configuration	Parallel	
Body Features		
Primary Product Color	Black	
Contact Features		
Mating Square Post Dimension	.64 mm[.025 in]	
	100 – 200 µin	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	Square	

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Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Fermination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.05 mm[.12 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention Type	Solder Tail
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	LCP (Liquid Crystal Polymer), LCP-GF (Liquid Crystal Polymer)
Dimensions	
PCB Thickness (Recommended)	1.6 mm[.063 in]
Jsage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
ndustry Standards	
	CSA LR7189, UL E28476
Approved Standards	C3/(EI() 107, OE E20470
Approved Standards UL Flammability Rating	UL 94V-0

**C** For support call+1 800 522 6752

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Packaging Quantity	100
Packaging Type	Carton
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free
Solder Process Capability	Pin-in-Paste capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

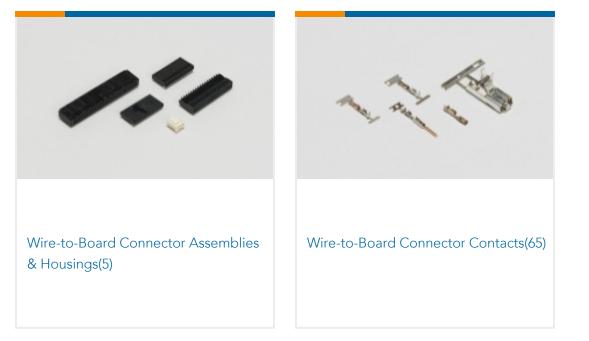


## Also in the Series AMPMODU Headers

PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers







## Customers Also Bought



TE Part #2-1462038-1 IM43NS=IM RELAY 100mW 5V BIS	TE Part #2834006-2 Poke-In Connector, BUCHANAN WireMate	TE Part #7-530689-6 CONN LOW PRO 22 POS 156X200C/	TE Part #282837-9 TERMI-BLOK PCB MOUNT 9P
TE TE	201 201 100 100 100 100 100 100 100 100		
TE Part #1676237-3 RN 0805 1K5 0.1% 10PPM 5KRL	TE Part #1-2176329-5 CRGP 1210 150R 1%	TE Part #9-2176380-1 RQ 0805 10K 0.1% 10PPM 5K RL	TE Part #5-2176389-6 RQ 1206 402R 0.1% 10PPM 5K RL



## Documents

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#### **CAD** Files

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_9-146281-0\_D.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_9-146281-0\_D.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_9-146281-0\_D.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU\_INTERCONNECTION\_SYSTEM\_SECTION5

English